

1SP0340x2x0-FZ1800R45HL4 and 1SP0340x2x0C-FZ1800R45HL4

Data Sheet

Compact, high-performance, plug-and-play single-channel IGBT driver based on SCALE™-2 technology for individual and parallel-connected modules in 2-level, 3-level and multilevel converter topologies

Abstract

The SCALE™-2 plug-and-play driver 1SP0340x2x0-FZ1800R45HL4 / 1SP0340x2x0C-FZ1800R45HL4 (Coated version using ELPEGUARD SL 1307 FLZ/2 from Lackwerke Peters with a typical thickness of 50µm) is a compact single-channel intelligent gate driver designed for Infineon's IGBTs FZ1800R45HL4. The master driver 1SP0340V2M0(C)-FZ1800R45HL4 features a fiber-optic interface. It can be used as stand-alone driver or in conjunction with up to three 1SP0340D2S0(C)-FZ1800R45HL4 slaves to drive up to four parallel-connected IGBT modules of type FZ1800R45HL4.

The DC/DC power supply must be purchased as a separate unit (one per master driver).

For drivers adapted to other types of high-power and high-voltage IGBT modules, refer to:

www.power.com/products/scale-2-plug-and-play-drivers

Features

- ✓ Plug-and-play solution
- ✓ Allows parallel connection of IGBT modules
- ✓ For 2-level, 3-level and multilevel topologies
- ✓ Fiber-optic links (master)
- ✓ Built-in interface to 1SP0340D2S0 (slave)
- ✓ Duty cycle 0...100%
- ✓ Dynamic Advanced Active Clamping DA²C
- ✓ Dynamic IGBT short-circuit protection
- ✓ Monitoring of supply voltage
- ✓ Monitoring of gate voltage
- ✓ Extremely reliable; long service life
- ✓ Shortens application development time
- ✓ Suitable for FZ1800R45HL4
- ✓ Lead-free

Applications

- ✓ Traction
- ✓ Railroad power supplies
- ✓ Light rail vehicles
- ✓ HVDC
- ✓ Flexible AC transmission systems (FACTS)
- Medium-voltage converters
- ✓ Industrial drives
- ✓ Wind-power converters
- ✓ Medical applications
- ✓ Research
- ✓ And many others



Safety Notice!

The data contained in this data sheet is intended exclusively for technically trained staff. Handling all high-voltage equipment involves risk to life. Strict compliance with the respective safety regulations is mandatory!

Any handling of electronic devices is subject to the general specifications for protecting electrostatic-sensitive devices according to international standard IEC 60747-1, Chapter IX or European standard EN 100015 (i.e. the workplace, tools, etc. must comply with these standards). Otherwise, this product may be damaged.

Important Product Documentation

This data sheet contains only product-specific data. For a detailed description, must-read application notes and common data that apply to the whole series, please refer to the "Description & Application Manual for 1SP0340 SCALE-2 IGBT Drivers" on www.power.com/products/scale-2-plug-and-play-drivers/1sp0340.

When applying SCALE-2 plug-and-play drivers, please note that these drivers are specifically adapted to a particular type of IGBT module. Therefore, the type designation of SCALE-2 plug-and-play drivers also includes the type designation of the corresponding IGBT module. These drivers are not valid for IGBT modules other than those specified. Incorrect use may result in failure.

Mechanical Dimensions

Dimensions: Refer to the relevant "Description and Application Manual"

Mounting principle: Connected to IGBT module with screws

Fiber-Optic Interfaces (1SP0340V2M0(C))

Interface	Remarks	Part type #
Drive signal input Status output	Fiber-optic receiver (Notes 1, 2) Fiber-optic transmitter (Notes 1, 3)	HFBR-2522ETZ HFBR-1522ETZ

Electrical Connectors

Interface	Remarks	Part type #
Power supply connector X1 Bus connectors X2 and X3	On-board connector (Note 4) On-board connectors (Note 5)	214012 214013



Absolute Maximum Ratings

Parameter	Remarks	Min	Max	Unit
Supply voltage V _{DC}	VDC to COM	0	30	V
Average supply current I_{DC}	1SP0340V2M0(C) only (Note 6)		180	mA
Average supply current IDC	1SP0340V2M0(C) with three 1SP0340D2S0(C) (Note	6)	620	mA
Gate output power	Ta ≤ 70°C		2.8	W
	Ta ≤ 85°C		2.1	W
Switching frequency f	Ta ≤ 70°C		2.8	kHz
	Ta ≤ 85°C		2.1	kHz
Gate peak current Iout	Note 7	-35	+35	Α
DC-link voltage	Switching operation (Note 8)		3000	V
	Off state (Note 9)		3550	V
Operating voltage	Collector-emitter voltage		4500	V_{peak}
Emitter-emitter voltage	Between parallel connected drivers (Note 10)		200	V_{peak}
dV/dt	Between parallel connected drivers (Note 11)		50	kV/μs
Interface current	X2 and X3, total RMS value (Note 12)		4	A_{rms}
	X2 and X3, total peak value (Note 12)		20	A_{peak}
Operating temperature		-40	85	°C
Storage temperature	Note 26	-40	50	°C
Surface temperature	Only 1SP0340x2x0C-FZ1800R45HL4 (Note 27)		125	°C

Recommended Operating Conditions

Power Supply	Remarks	Min	Тур	Max	Unit
Supply voltage V _{DC}	To COM	23.5	25	26.5	V



Electrical Characteristics

All data refer to $+25^{\circ}\text{C}$ and $V_{\text{DC}} = 25\text{V}$ unless otherwise specified

Power Supply	Remarks	Min	Тур	Max	Unit
Supply current I _{DC}	Without load, only 1SP0340V2M0(C) Without load, per additional 1SP0340D2S0(C)		47 20		mA mA
Power Supply Monitoring	Remarks	Min	Тур	Max	Unit
Supply threshold V _{iso} -V _{ee}	Clear fault	11.6	12.6	13.6	V
	Set fault (Note 13)	11.0	12.0	13.0	V
Monitoring hysteresis	Set/clear fault	0.35			٧
Supply threshold Vee-VCOM	Clear fault		5.15		V
	Set fault (Note 13)		4.85		V
Monitoring hysteresis	Set/clear fault		0.3		V
Bus to 1SP0340D2S0(C)	Remarks	Min	Тур	Max	Unit
Supply voltage			VDC		
Turn-off command	To COM		0		V
Turn-on command	To COM		15		V
Gate Monitoring	Remarks	Min	Тур	Max	Unit
Turn-on threshold V _{GE,on,min}	G _{mean} to E, set fault (Note 14)		12.9		V
Turn-off threshold V _{GE,off,max}	G _{mean} to E, set fault (Note 14)		-7.6		V
Filter delay	Turn-on (Note 14)		32		μs
	Turn-off (Note 14)		47		μs
Short-circuit Protection	Remarks	Min	Тур	Max	Unit
Static V _{CE} -monitoring threshold	Between auxiliary terminals (Note 15)		170		٧
Response time	DC-link voltage = 3000V (Note 16)		6.5		μs
	DC-link voltage = 2000V (Note 16)		6.5		μs
	DC-link voltage = 1500V (Note 16)		6.5		μs
	DC-link voltage = 1000V (Note 16)		9.7		μs
Delay to IGBT turn-off t _{CSHD}	After the response time (Note 17)		0.3		μs
Timing Characteristics	Remarks	Min	Тур	Max	Unit
	N		170		ns
Turn-on delay t _{d(on)}	Note 18		1/0		
Turn-on delay t _{d(on)} Turn-off delay t _{d(off)}	Note 18 Note 18		160		ns
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Timing Characteristics	Remarks	Min	Тур	Max	Unit
Transmission delay of fault state	Note 20		90		ns
Delay to clear fault state t(block)	After IGBT short circuit (Note 21)		9		μs
	After gate-monitoring fault (Notes 21, 25)		1		μs
Acknowledge delay time t _{d(ack)}	Note 22		230		ns
Acknowledge pulse width $t_{(ack)}$	On host side	400	700	1050	ns
Gate Output	Remarks	Min	Тур	Max	Unit
Turn-on gate resistor R _{g(on)}	Note 23		0.775		Ω
Turn-off gate resistor R _{g(off)}	Note 23		5.375		Ω
Auxiliary gate capacitor Cge		not	assemb	oled	nF
Gate voltage at turn-on	Note 24		15		V
Gate-voltage at turn-off	Note 24		-10		V

Footnotes to the Key Data

- 1) The transceivers required on the host controller side are not supplied with the gate driver. It is recommended to use the same types as used in the gate driver.
- 2) The recommended transmitter current at the host controller is 20mA. A higher current may increase jitter or delay at turn-off.
- 3) The typical transmitter current at the gate driver is 20mA. In case of supply undervoltage, the minimum transmitter current at the gate driver is 14mA: this is suitable for adequate plastic optical fibers with a length of up to 10 meters.
- 4) This refers to the manufacturer ordering number. The customer-side connector as well as cables with different lengths can be supplied by Power Integrations. Refer to the "Description & Application Manual for 1SP0340 SCALE-2 IGBT Drivers" for more information.
- 5) This refers to the manufacturer ordering number. These connectors are to be used to connect 1SP0340V2M0(C) (master) or 1SP0340D2S0(C) (slave) to 1SP0340D2S0(C) (slave) if parallel connection of IGBT modules is required. Cables with different lengths can be supplied by Power Integrations. Refer to the "Description & Application Manual for 1SP0340 SCALE-2 IGBT Drivers" for more information.
- 6) If the specified value is exceeded, this indicates a driver overload. It should be noted that the driver is not protected against overload.
- 7) The gate current is limited by the gate resistors located on the driver and the load.
- 8) This limit is due to active clamping under switching conditions. Refer to the "Description & Application Manual for 1SP0340 SCALE-2 IGBT Drivers".
- 9) Due to the Dynamic Active Advanced Clamping Function (DA²C) implemented on the driver, the DC-link voltage can be increased in the off-state condition (e.g. after emergency shut-down). This value is only valid when the IGBTs are in the off state (not switching). The time during which the voltage can be applied should be limited to short periods (< 60 seconds). Refer to the "Description & Application Manual for 1SP0340 SCALE-2 IGBT Drivers".
- 10) The maximum dynamic voltage between auxiliary emitters of parallel-connected drivers due to asymmetrical operation at turn-on and turn-off must be limited to the given value.
- 11) Maximum allowed rate of change between auxiliary emitter voltages of parallel connected drivers.
- 12) Dynamic voltages between auxiliary emitters of parallel connected drivers at turn-on and turn-off lead to equalizing currents over the X2 or X3 bus. The peak and RMS values of the resulting current must be limited to the given value.
- 13) Undervoltage monitoring of the secondary-side supply voltage (Viso to Vee and Vee to COM which correspond with the approximate turn-on and turn-off gate-emitter voltages). If the corresponding voltage drops below this limit on 1SP0340V2M0(C) (masters), all paralleled IGBTs (master and slaves) are switched off and a fault is transmitted to the status output. If the corresponding voltage drops



- below this limit on 1SP0340D2S0(C) (slaves), the corresponding IGBT is switched off. If the IGBT was turned on, a fault will be generated by the gate-monitoring function on the master which will turn off all paralleled IGBT after the corresponding delay.
- 14) The average value V_{GE,mean} of all gate voltages (master and all slaves) is filtered and compared to the given values at turn-on and turn-off. If the specified values are exceeded (V_{GE,mean} < V_{GE,on,min} at turn-on resp. V_{GE,mean} > V_{GE,off,max} at turn-off) after the given filter delay, the driver turns off all parallel-connected IGBTs and a fault is transmitted to the status output.
- 15) A dynamic V_{CE} protection is implemented on the driver. The maximum allowed V_{CE} voltage at turn-on is dynamically adjusted in order to better fit to the IGBT characteristics at turn-on. At the end of the turn-on process the given static value applies.
- 16) The resulting pulse width of the direct output of the gate drive unit for short-circuit type I (excluding the delay of the gate resistors) is the sum of the response time plus the delay to IGBT turn-off.
- 17) The turn-off event of the IGBT is delayed by the specified time after the response time.
- 18) Including the delay of the external fiber-optic links (cable length: 1m). Measured from the transition of the turn-on or turn-off command at the optical transmitter on the host controller side to the direct output of the gate drive unit (excluding the delay of the gate resistors).
- 19) Output rise and fall times are measured between 10% and 90% of the nominal output swing. The values are given for the driver side of the gate resistors with $2\Omega/1$ uF load. The time constant of the output load in conjunction with the present gate resistors leads to an additional delay at their load side.
- 20) Delay of external fiber-optic links. Measured from the driver secondary side (ASIC output) to the optical receiver on the host controller with a 1m cable.
- 21) Measured on the host side. The fault status on the secondary side is automatically reset after the specified time.
- 22) Including the delay of the external fiber-optic links (cable length: 1m). Measured from the transition of the turn-on or turn-off command at the optical transmitter on the host controller side to the transition of the acknowledge signal at the optical receiver on the host controller side.
- 23) The gate resistors can be leaded or surface mounted. Power Integrations reserves the right to determine which type will be used. Typically, higher quantities will be produced with SMD resistors and small quantities with leaded resistors.
- 24) The driver supply voltage VDC is split into two distinct voltages on the driver. The first one is the turn-on voltage which is regulated at about 15V. The difference between VDC and the turn-on voltage is the turn-off voltage which is not regulated and mainly dependent on the driver input voltage VDC.
- 25) The given value applies if the driver goes from the "off state" to the "on state" and the gate-emitter voltage of one or more parallel connected drivers does not turn on. If the driver goes from the "on state" to the "off state" and the gate-emitter voltage of one or more parallel connected drivers does not turn off, the fault status is applied as long as the gate monitoring fault is present.
- The storage temperature inside the original package (1) or in case the coating material of coated products may touch external parts (2) must be limited to the given value. Otherwise, it is limited to 90°C.
- 27) The component surface temperature, which may strongly vary depending on the operating condition, must be limited to the given value for coated driver versions to ensure long-term reliability of the coating material.



RoHS Statement

We hereby confirm that the product supplied does not contain any of the restricted substances according Article 4 of the RoHS Directive 2011/65/EU in excess of the maximum concentration values tolerated by weight in any of their homogeneous materials.

Additionally the product complies with RoHS Directive 2015/863/EU (known as RoHS 3) from 31 March 2015, which amends Annex II of Directive 2011/65/EU.

Legal Disclaimer

The statements, technical information and recommendations contained herein are believed to be accurate as of the date hereof. All parameters, numbers, values and other technical data included in the technical information were calculated and determined to our best knowledge in accordance with the relevant technical norms (if any). They may base on assumptions or operational conditions that do not necessarily apply in general. We exclude any representation or warranty, express or implied, in relation to the accuracy or completeness of the statements, technical information and recommendations contained herein. No responsibility is accepted for the accuracy or sufficiency of any of the statements, technical information, recommendations or opinions communicated and any liability for any direct, indirect or consequential loss or damage suffered by any person arising therefrom is expressly disclaimed.



Ordering Information

Our international terms and conditions of sale apply.

Interface	Power Integrations Driver Type #	Related IGBT
Master, Fiber-Optic Interface	1SP0340V2M0-FZ1800R45HL4	FZ1800R45HL4
Master, Fiber-Optic Interface ¹⁾	1SP0340V2M0C-FZ1800R45HL4	FZ1800R45HL4
Slave, Electrical Interface	1SP0340D2S0-FZ1800R45HL4	FZ1800R45HL4
Slave, Electrical Interface ¹⁾	1SP0340D2S0C-FZ1800R45HL4	FZ1800R45HL4

Product home page: www.power.com/products/scale-2-plug-and-play-drivers/1sp0340

Information about Other Products

For other drivers, product documentation and application support:

Please click onto: www.power.com/products/gate-drivers



Power Integrations Sales Offices

WORLD HEADQUARTERS

5245 Hellyer Avenue San Jose, CA 95138 USA Tel: +1-408-414-9200 Fax: +1-408-414-9765 Email: usasales@power.com

AMERICAS WEST

5245 Hellyer Avenue San Jose, CA 95138 USA Tel: +1-408-414-8778 Fax: +1-408-414-3760 Email: usasales@power.com

GERMANY (AC-DC/LED Sales)

Einsteinring 24 85609 Aschheim, Germany Tel: +49-89-5527-39100 Fax: +49-89-1228-5374 Email: eurosales@power.com

INDIA (Mumbai)

Unit: 106-107, Sagar Tech Plaza-B Sakinaka, Andheri Kurla Road Mumbai, Maharashtra 400072 India Tel 1: +91-22-4003-3700 Tel 2: +91-22-4003-3600 Email: indiasales@power.com

JAPAN

Kosei Dai-3 Bldg. 2-12-11, Shin-Yokohama, Kohoku-ku Yokohama-shi, Kanagawa Japan 222-0033 Tel: +81-45-471-1021

Fax: +81-45-471-3717 Email: <u>japansales@power.com</u>

TAIWAN

5F, No. 318, Nei Hu Rd., Sec. 1 Nei Hu Dist.

Taipei, 114 Taiwan Tel: +886-2-2659-4570 Fax: +886-2-2659-4550 Email: <u>taiwansales@power.com</u>

AMERICAS EAST

7360 McGinnis Ferry Road Suite 225 Suwannee, GA 30024 USA Tel: +1-678-957-0724 Fax: +1-678-957-0784 Email: usasales@power.com

CHINA (Shanghai) Room 2410, Charity Plaza No. 88 North Caoxi Road Shanghai, 200030 China Tel: +86-21-6354-6323 Fax: +86-21-6354-6325

GERMANY (Gate Driver Sales)

Email: chinasales@power.com

HellwegForum 3 59469 Ense, Germany Tel: +49-2938-64-39990

Email: gate-drivers.sales@power.com

INDIA (New Delhi) #45, Top Floor

Okhla Industrial Area, Phase - III New Dehli, 110020 India Tel 1: +91-11-4055-2351 Tel 2: +91-11-4055-2353 Email: indiasales@power.com

KOREA

RM602, 6FL, 22 Teheran-ro 87-gil, Gangnam-gu Seoul, 06164 Korea Tel: +82-2-2016-6610 Fax: +82-2-2016-6630 Email: koreasales@power.com

UNITED KINGDOM

Building 5, Suite 21 The Westbrook Centre Milton Road Cambridge, CB4 1YG United Kingdom

Tel: +44-7823-557-484 Email: <u>eurosales@power.com</u>

AMERICAS CENTRAL

333 Sheridan Road Winnetka, IL 60093 USA Tel: +1-847-721-6293 Email: usasales@power.com

CHINA (Shenzhen)

17/F, Hivac Building, No 2 Keji South 8th Road, Nanshan District Shenzhen, 518057 China

Tel: +86-755-8672-8689 Fax: +86-755-8672-8690 Email: <u>chinasales@power.com</u>

INDIA (Bangalore) #1, 14th Main Road

Vasanthangar Bangalore, 560052 India Tel 1: +91-80-4113-8020 Tel 2: +91-80-4113-8028 Fax: +91-80-4113-8023 Email: indiasales@power.com

ITALY

Via Milanese 20 20099 Sesto San Giovanni (MI), Italy Tel: +39-02-4550-8708 Email: eurosales@power.com

SINGAPORE

51 Newton Road #19-01/05 Goldhill Plaza Singapore, 308900 Tel 1: +65-6358-2160 Tel 2: +65-6358-4480 Fax: +65-6358-2015

Email: singaporesales@power.com